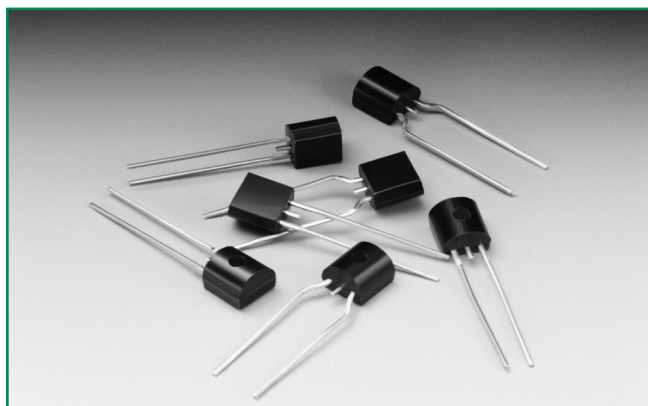



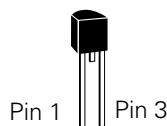
SIDACtor® Series - TO-92



Agency Approvals

Agency	Agency File Number
	E133083

Pinout Designation



Schematic Symbol



Description

SIDACtor® Series TO-92 are designed to protect baseband equipment such as modems, line cards, CPE and DSL from damaging overvoltage transients.

The series provides a robust through-hole solution that enables equipment to comply with global regulatory standards.

Features and Benefits

- Low voltage overshoot
- Low on-state voltage
- Does not degrade surge capability after multiple surge events within limit.
- Fails short circuit when surged in excess of ratings
- Low capacitance
- 2nd level interconnect is Pb-free per IPC/ JEDEC J-STD-609A.01

Applicable Global Standards

- TIA-968-A
- TIA-968-B
- ITU K.20/21 Enhanced Level*
- ITU K.20/21 Basic Level
- GR 1089 Inter-building*
- GR 1089 Intra-building
- IEC 61000-4-5
- YD/T 1082
- YD/T 993
- YD/T 950

* A/B-rated parts require series resistance

Electrical Characteristics

Part Number	Marking	V_{DRM}	V_S	I_H	I_S	I_T	V_T	Capacitance	
		@ $I_{DRM}=5\mu A$	@ 100V/ μs	mA min	mA max	A max	@ $I_T=2.2$ Amps	@ 1MHz, 2V bias	
		V min	V max				V max	pF min	pF max
P0080EALxxx	P0080EA	6	25	50	800	2.2	4	25	150
P0300EALxxx	P0300EA	25	40	50	800	2.2	4	15	140
P0640EALxxx	P0640EA	58	77	150	800	2.2	4	40	60
P0720EALxxx	P0720EA	65	88	150	800	2.2	4	35	60
P0900EALxxx	P0900EA	75	98	150	800	2.2	4	35	55
P1100EALxxx	P1100EA	90	130	150	800	2.2	4	30	50
P1300EALxxx	P1300EA	120	160	150	800	2.2	4	25	45
P1500EALxxx	P1500EA	140	180	150	800	2.2	4	25	40
P1800EALxxx	P1800EA	170	220	150	800	2.2	4	25	35
P2300EALxxx	P2300EA	190	260	150	800	2.2	4	25	35
P2600EALxxx	P2600EA	220	300	150	800	2.2	4	20	35
P3100EALxxx	P3100EA	275	350	150	800	2.2	4	20	35
P3500EALxxx	P3500EA	320	400	150	800	2.2	4	20	35

Table continues on next page.

Electrical Characteristics (continued)

Part Number	Marking	V_{DRM} @ $I_{DRM}=5\mu A$	V_S @ 100V/ μs	I_H	I_S	I_T	V_T @ $I_T=2.2$ Amps	Capacitance @ 1MHz, 2V bias	
		V Min	V Max	mA Min	mA Max	A Max	V Max	pF Min	pF Max
P0080EBLxxx	P0080EB	6	25	50	800	2.2	4	25	150
P0300EBLxxx	P0300EB	25	40	50	800	2.2	4	15	140
P0640EBLxxx	P0640EB	58	77	150	800	2.2	4	40	60
P0720EBLxxx	P0720EB	65	88	150	800	2.2	4	35	75
P0900EBLxxx	P0900EB	75	98	150	800	2.2	4	35	70
P1100EBLxxx	P1100EB	90	130	150	800	2.2	4	30	70
P1300EBLxxx	P1300EB	120	160	150	800	2.2	4	25	60
P1500EBLxxx	P1500EB	140	180	150	800	2.2	4	25	55
P1800EBLxxx	P1800EB	170	220	150	800	2.2	4	25	50
xxx	P2300EB	190	260	150	800	2.2	4	25	50
P2600EBLxxx	P2600EB	220	300	150	800	2.2	4	20	45
P3100EBLxxx	P3100EB	275	350	150	800	2.2	4	20	45
P3500EBLxxx	P3500EB	320	400	150	800	2.2	4	20	40
P0080ECLxxx	P0080EC	6	25	50	800	2.2	4	35	260
P0300ECLxxx	P0300EC	25	40	50	800	2.2	4	25	250
P0640ECLxxx	P0640EC	58	77	150	800	2.2	4	55	155
P0720ECLxxx	P0720EC	65	88	150	800	2.2	4	50	150
P0900ECLxxx	P0900EC	75	98	150	800	2.2	4	45	140
P1100ECLxxx	P1100EC	90	130	150	800	2.2	4	45	115
P1300ECLxxx	P1300EC	120	160	150	800	2.2	4	40	105
P1500ECLxxx	P1500EC	140	180	150	800	2.2	4	35	95
P1800ECLxxx	P1800EC	170	220	150	800	2.2	4	35	90
P2300ECLxxx	P2300EC	190	260	150	800	2.2	4	30	80
P2600ECLxxx	P2600EC	220	300	150	800	2.2	4	30	80
P3100ECLxxx	P3100EC	275	350	150	800	2.2	4	30	70
P3500ECLxxx	P3500EC	320	400	150	800	2.2	4	25	65

Notes:
 - Absolute maximum ratings measured at $T_J = 25^\circ C$ (unless otherwise noted).
 - Devices are bi-directional (unless otherwise noted).

Notes:
 - xxx part number suffix: 'AP' = Ammo Pack, 'RP1' and 'RP2' = Reel Pack, blank = Bulk Pack

Surge Ratings

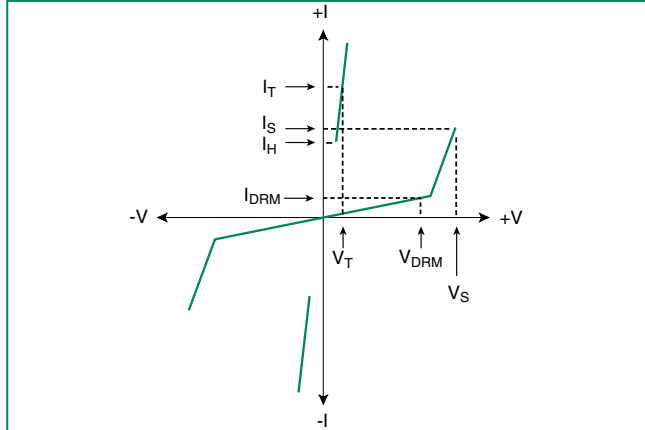
Series	I_{PP}									I_{TSM} 50/60 Hz	di/dt
	0.2x310 ¹	2x10 ¹	8x20 ¹	10x160 ¹	10x560 ¹	5x320 ¹	10x360 ¹	10x1000 ¹	5x310 ¹		
	0.5x700 ²	2x10 ²	1.2x50 ²	10x160 ²	10x560 ²	9x720 ²	10x360 ²	10x1000 ²	10x700 ²		
	A min	A min	A min	A min	A min	A min	A min	A min	A min	A min	A/ μs max
A	20	150	150	90	50	75	75	45	75	20	500
B	25	250	250	150	100	100	125	80	100	25	500
C	50	500	400	200	150	200	175	100	200	30	500

Notes:
 1 Current waveform in μs
 2 Voltage waveform in μs
 - Peak pulse current rating (I_{PP}) is repetitive and guaranteed for the life of the product that remains in thermal equilibrium.
 - I_{PP} ratings applicable over temperature range of $-40^\circ C$ to $+85^\circ C$
 - The device must initially be in thermal equilibrium with $-40^\circ C \leq T_J \leq +150^\circ C$

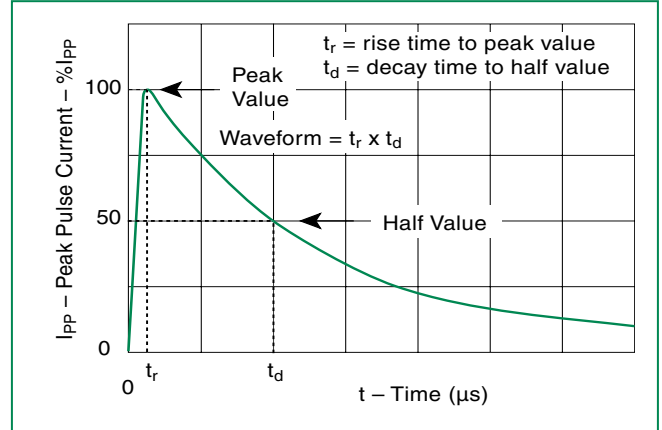
Thermal Considerations

Package	Symbol	Parameter	Value	Unit
TO-92 	T_J	Operating Junction Temperature Range	-40 to +150	$^\circ C$
	T_S	Storage Temperature Range	-65 to +150	$^\circ C$
	$R_{\theta JA}$	Thermal Resistance: Junction to Ambient	90	$^\circ C/W$

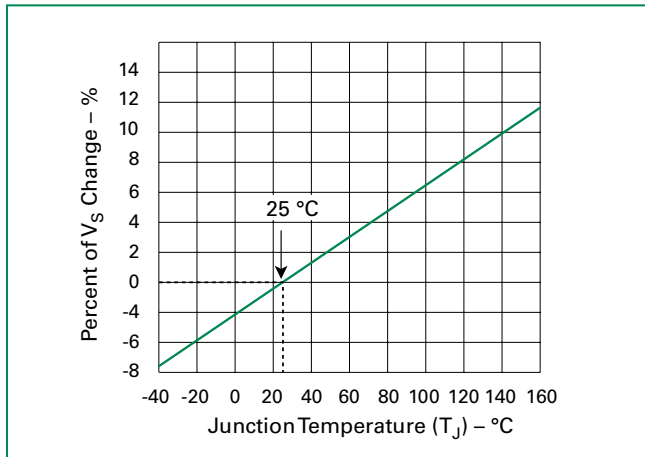
V-I Characteristics



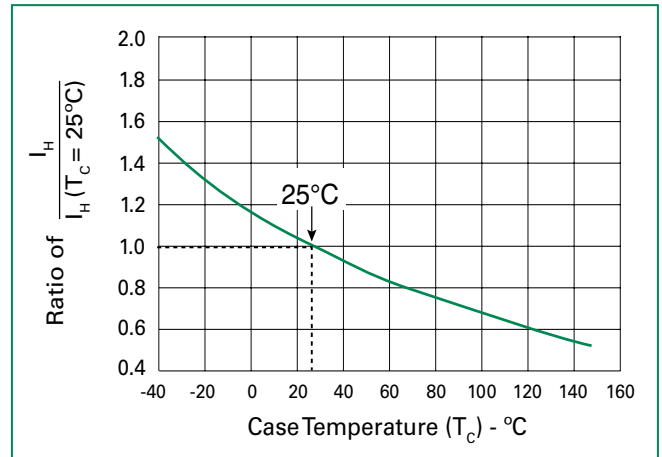
$t_r \times t_d$ Pulse Waveform



Normalized V_S Change vs. Junction Temperature

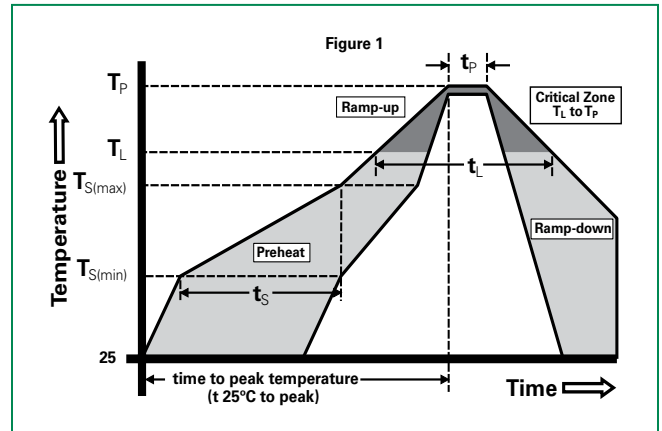


Normalized DC Holding Current vs. Case Temperature



Soldering Parameters

Reflow Condition		Pb-Free assembly (see Fig. 1)
Pre Heat	-Temperature Min ($T_{s(min)}$)	+150 $^{\circ}C$
	-Temperature Max ($T_{s(max)}$)	+200 $^{\circ}C$
	-Time (Min to Max) (t_s)	60-180 secs.
Average ramp up rate (Liquidus Temp (T_L) to peak)		3 $^{\circ}C/sec.$ Max.
$T_{s(max)}$ to T_L - Ramp-up Rate		3 $^{\circ}C/sec.$ Max.
Reflow	-Temperature (T_L) (Liquidus)	+217 $^{\circ}C$
	-Temperature (t_L)	60-150 secs.
Peak Temp (T_p)		+260(+0/-5) $^{\circ}C$
Time within 5 $^{\circ}C$ of actual Peak Temp (t_p)		30 secs. Max.
Ramp-down Rate		6 $^{\circ}C/sec.$ Max.
Time 25 $^{\circ}C$ to Peak Temp (T_p)		8 min. Max.
Do not exceed		+260 $^{\circ}C$



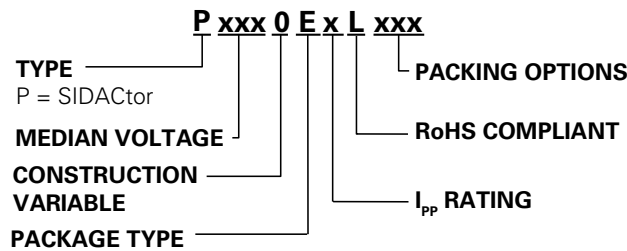
Physical Specifications

Lead Material	Copper Alloy
Terminal Finish	100% Matte-Tin Plated
Body Material	UL recognized epoxy meeting flammability classification 94V-0

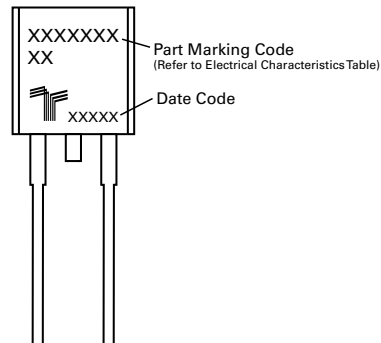
Environmental Specifications

High Temp Voltage Blocking	80% Rated V_{DRM} (V_{AC} Peak) +125°C or +150°C, 504 or 1008 hrs. MIL-STD-750 (Method 1040) JEDEC, JESD22-A-101
Temp Cycling	-65°C to +150°C, 15 min. dwell, 10 up to 100 cycles. MIL-STD-750 (Method 1051) EIA/JEDEC, JESD22-A104
Biased Temp & Humidity	52 V_{DC} (+85°C) 85%RH, 504 up to 1008 hrs. EIA/JEDEC, JESD22-A-101
High Temp Storage	+150°C 1008 hrs. MIL-STD-750 (Method 1031) JEDEC, JESD22-A-101
Low Temp Storage	-65°C, 1008 hrs.
Thermal Shock	0°C to +100°C, 5 min. dwell, 10 sec. transfer, 10 cycles. MIL-STD-750 (Method 1056) JEDEC, JESD22-A-106
Autoclave (Pressure Cooker Test)	+121°C, 100%RH, 2atm, 24 up to 168 hrs. EIA/JEDEC, JESD22-A-102
Resistance to Solder Heat	+260°C, 30 secs. MIL-STD-750 (Method 2031)
Moisture Sensitivity Level	85%RH, +85°C, 168 hrs., 3 reflow cycles (+260°C Peak). JEDEC-J-STD-020, Level 1

Part Numbering



Part Marking



Packing Options

Package Type	Description	Packing Options Quantity	Added Suffix	Lead Spacing	Industry Standard
E	TO-92 Tape and Reel Pack	2000	RP1	0.1 inch (2.54mm)	EIA-481-D
	TO-92 Ammo Pack		RP2	0.2 inch (5.08mm)	
	TO-92 Bulk Pack		AP		EIA-468-B
			N/A		N/A

Additional Information



Datasheet



Resources



Samples